



A full listing of our global operations and sales network is available on our website.

Products for Semiconductor Applications

Specialized products and professional services

Meeting your needs in semiconductor applications

About FITOK

Founded in 1998, FITOK Group has been a global leading supplier of valves and fittings, having our factories in Germany, USA and China (Wuhan, Shenzhen, Suzhou), and inventory and sales service centers in Germany, USA, China and UAE.

Our Advantages:

- 1. Specialized in instrumentation valves and fittings: over 25 years of rich design and manufacturing experience, products sold in more than 100 countries and regions.
- 2. Superior R&D capabilities: 100+ professional engineers and 80+ patents.
- 3. Lean and reliable quality management: a variety of management system certifications and product certifications.
- 4. Fast and efficient product delivery: manufacturing bases and service centers globally for faster product delivery and timely response to customers' needs.









FITOK, Inc. Manufacturing & Global Sales Center - Texas, USA



FITOK GmbH

Manufacturing to Order
-Offenbach, Germany



FITOK Middle East
Regional Sales & Service Center
- Dubai, UAE



FITOK (Wuhan) Incorporated

Manufacturing to Stock
- Wuhan, China



FITOK Incorporated

Manufacturing to Order
- Shenzhen, China



FITOK (Suzhou)

Metal Products Co., Ltd

Manufacturing - Tubing
- Suzhou, China

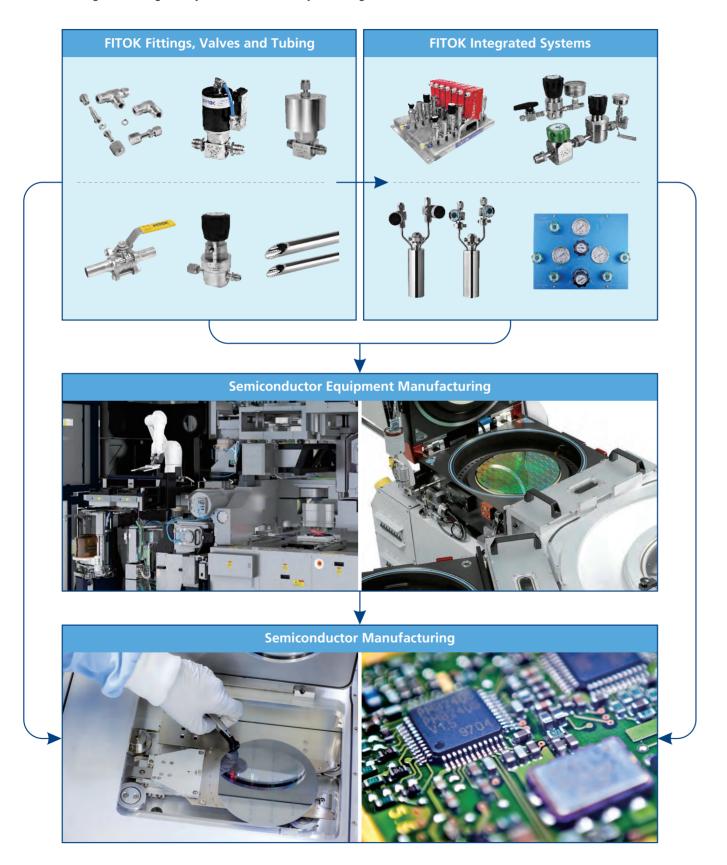
O1 Products for Semiconductor Applications





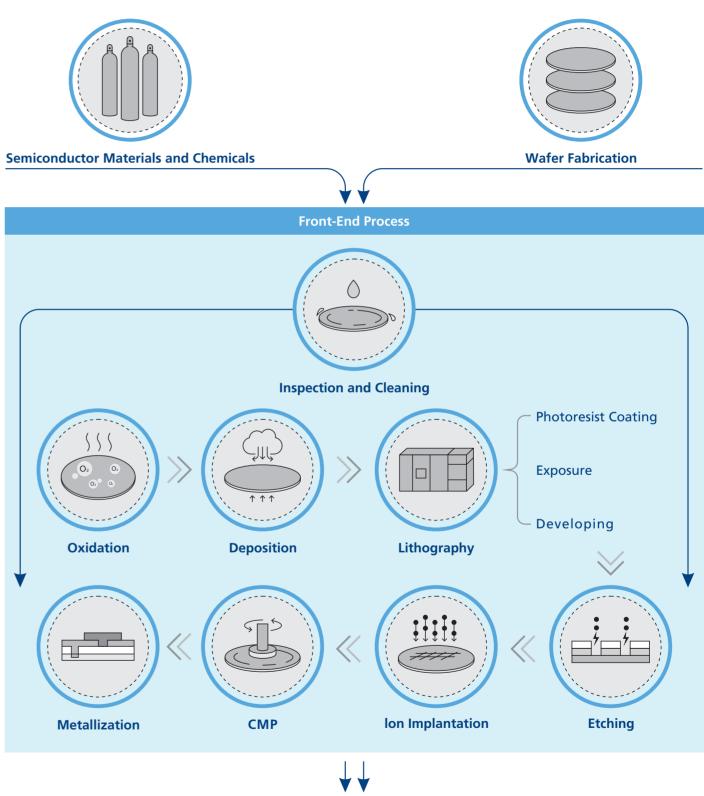
Single-Source Supplier of Fluid Systems for Semiconductor Industry:

FITOK can provide one-stop solutions for fluid systems in the semiconductor industry, from ultra high purity components such as fittings, valves and tubing to the integrated systems, and from the system design to the installation site service.



Application of FITOK Products in Semiconductor Manufacturing Process:

As a global leading supplier of valves and fittings, FITOK provides a full range of valves and fittings for semiconductor raw material production, semiconductor equipment manufacturing, semiconductor manufacturing process and the piping system construction and maintenance of semiconductor facility.



Back-End Process



Products for Semiconductor Applications

Features

Raw Materials

The purity of raw materials is critical to achieving fine surface for fluid system components. And finer surface contributes to more excellent process cleanliness.

FITOK has customized 316L SS, 316L SS VAR or 316L SS VIM-VAR meeting SEMI F20 standard for the valve body. Compared with 316L SS, 316L SS VAR and 316L SS VIM-VAR are more homogeneous with less inclusion, which contribute to finer surface and better corrosion resistance.





FITOK adopts cobalt alloy complying with AMS 5876 standard or Hastelloy complying with ASTM B575 standard as diaphragm material to achieve high corrosion resistance and excellent durability.

O Ultra High Purity Process

1. Electropolishing

The internal surface of ultra high purity products for the semiconductor industry is electropolished to improve the smoothness of the flow path and to form a chromium-rich layer on the metal surface to improve corrosion resistance, and the electropolished products are passivated to remove free iron ions. After electropolishing, the following testing standards can be achieved.

	Test Standard		
Oxide layer thickness		SEMI F72	
Surface defect analysis	max. defect counts per area within 5 sample areas	SEMI F73	
Cr/Fe	SEMI F60		
CrO/FeO	SEIVII FOU		
Surface roughn	SEMI F37		







2. Cleaning

Ultra high purity products for the semiconductor industry are rinsed with ultrasonic DI water in the NEBB-certified ISO 5 cleanroom and dried in an enclosed oven. The technical specifications of the DI water comply with SEMI E49 standard.

3. Welding, Assembly and Testing

- Cleaned products are welded, assembled, tested and inspected in the NEBB-certified ISO 4 cleanroom
- Helium leak test for products as required by SEMI F1. INFICON helium leak detector with a minimum detectable leak rate (vacuum) < 5x10⁻¹² mbar·L/s.





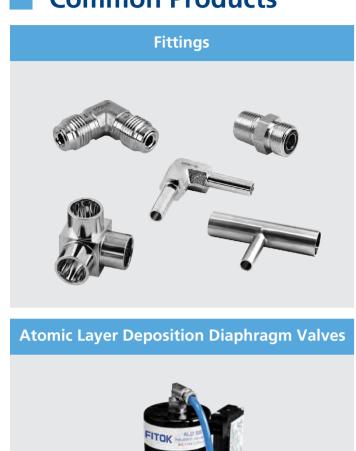
4. Packaging

- Ultra high purity products are packaged in the ISO 4 cleanroom and the product packaging complies with SEMI E49 standard.
- Products are end-capped and double bagged with inner vacuum-sealed clean polyethylene bag and outer polyethylene bag.

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Common Products







More Information











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Featured Products

Atomic Layer Deposition Diaphragm Valves

FITOK ALD series atomic layer deposition diaphragm valves are used in the atomic layer deposition process to deliver precise doses of gases during the deposition process for semiconductor manufacturing, to achieve the highly consistent film deposition required for advanced technology.



* Tested under ideal conditions in the laboratory, the performance in actual application is subject to test under actual



Response time less than 5 ms



Flow coefficient (Cv) consistency ±3%



Cycle life more than 40 million times



Temperature up to 392 °F (200 °C)



Flow coefficient (Cv) 0.27 or 0.62

- ♦ Thermal actuator extends the life in applications where the body is heated
- ◆ Contained seat to provide excellent resistance to swelling and contamination
- ◆ Cobalt alloy diaphragm to provide high strength and corrosion resistance to ensure long cycle life
- ♦ High-purity grade PFA seat with broad chemical compatibility
- ♦ Minimum particles and dead space to facilitate purging
- ◆ Valves with inductive sensors, solenoid valve assemblies, heater cartridge and thermocouple holes are available

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As surface mount diaphragm valves, pneumatic diaphragm valves with locking device are suitable for high purity and ultra high purity fluid systems.

- ♦ Manual and pneumatic operating mechanisms prevent misoperation better than traditional pneumatic diaphragm valves
- Compact design
- ◆ Comply with SEMI PR 3.1 seal specification
- ◆ W-seal and C-seal available

Surface Mount Size	Material	Cv	Temperature	Working Pressure	Internal Surface Roughness	Internal Leakage (Helium)	External Leakage (Helium)
1.125"	Body: 316L VAR	0.3	14 ~ 140 °F (-10 ~ 60 °C)	150 psig (10.4 bar)	Ra≤5 µin. (0.13 µm)	≤1x10° std cm³/s	
	Seat: PCTFE						
	Diaphragm: cobalt alloy						
	Actuator: aluminum						

Two-Step Pneumatic Diaphragm Valves



Two-step pneumatic diaphragm valves are used in the semiconductor industry to prevent fluid from flowing rapidly into the cavity and other internal areas of the semiconductor processing machine, which may cause particles to fly around to contaminate the cavity.

- Pneumatic actuated
- ♦ With high and low flow gas connections, high and low flow can be accurately switched to moderate the pressure rise in the cavity

Size	Material	Low Flow Cv	High Flow Cv	Temperature	Working Pressure	Internal Surface Roughness	Internal Leakage (Helium)	External Leakage (Helium)
	Body: 316L, 316L VAR, 316L VIM-VAR	0.02 ~ 0.12	0.27	PFA: 14 ~ 302 °F (-10 ~ 150 °C) PCTFE: 14 ~ 176 °F (-10 ~ 80 °C)	Vacuum to 145 psig (10 bar)	Ra≤5 μin. (0.13 μm)	≤1x10° std cm³/s	
1/4"	Seat: PFA, PCTFE							
	Diaphragm: cobalt alloy							
	Actuator: aluminum							

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Stainless Steel Electropolished Tubing (EP Tubing)

FITOK provides EP tubing with excellent roughness, cleanliness, and corrosion resistance by strictly controlling raw materials, electropolishing process, cleaning and packaging. FITOK EP tubing meets the high requirements of surface quality, purity, etc. in the semiconductor application.



- ◆ Materials: 316L, 316L VAR, 316L VIM-VAR
- ♦ Inspection: visual inspection, surface roughness measurement, particle testing, moisture testing and a series of tests with scanning electron microscopy (SEM), Auger electron spectroscopy (AES), electron spectroscopy for chemical analysis (ESCA or XPS)
- ◆ Sufficient Inventory: with flexible manufacturing systems and sufficient finished goods inventory in global warehouses, FITOK help customers save procurement and inventory costs, and reduce lead time
- ◆ Prefabrication services: FITOK can provide EP bent tubing and prefabricate EP bent tubing assemblies upon request to improve the installation efficiency for customers

Product	Standard	O.D.	External Surface Roughness	Internal Surface Roughness	Length
TEP Series	ASTM A269/A632	1/4" ~ 2 1/2"		Ra≤5 μin. (0.13 μm)	4m, 6m, 20ft
DED Carios	JIS G3459	6A ~ 50A	Ra≤40 μin. (1 μm)	Ra≤7 μin. (0.18 μm)	4m, 6m
PEP Series	ASTM A312	NPS 1/8 ~ NPS 2		Ra≤10 µin. (0.25 μm)	4m, 6m, 20ft

Gas Stick Assemblies

FITOK gas stick assemblies integrate a ball valve, a diaphragm valve, a regulator, a pressure gauge and etc. into one stick to reduce site connections for easier site installation. FITOK gas stick assemblies, including AGH series high purity gas stick assemblies and AGL series general gas stick assemblies, are widely used in the semiconductor industry.

AGH Series

- Applicable to high purity gas systems in the semiconductor industry
- Integrated from a diaphragm valve, a regulator and a pressure gauge
- Alloy diaphragm improves strength and corrosion resistance for long cycle life
- ◆ T series tubular fittings optional for pressure gauge connection (customized lengths available)
- Cleaned, welded, assembled, tested, packaged and marked following Ultra High Purity Process Specification
- ♦ Sizes from 1/4" to 1" optional



AGL Series

- Applicable to general gas fluid systems and oxygenenriched environments
- ♦ Integrated from a ball valve, a regulator and a pressure gauge
- Excellent sensitivity and set point pressure stability for precise pressure control and fluid shutoff
- Alloy diaphragm improves strength and corrosion resistance for long cycle life
- Special Cleaning and Packaging Process Specification ensures the product cleanliness meets the requirements of ASTM G93 Level C
- ♦ Sizes from 1/4" to 1" optional

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○ Integrated Gas Systems

Integrated Gas Systems are used for gas control in the semiconductor industry. As semiconductor manufacturing process develops, the requirements for gas control device become higher. FITOK Integrated Gas Systems use SEMI compliant surface-mounted components and are modularly designed. While reducing the size of the device, installation and maintenance become easier.

Step 1: System Design **Step 3**: Substrate Installation Design a sophisticated general assembly drawing conforming to gas flow process Install substrates according to based on customer's flow chart general assembly drawing Step 2: Component Selection and Manufacturing Select and manufacture components after the customer confirms the general assembly drawing **Production Process of FITOK Integrated Gas Systems Step 4**: Surface Component Installation Install surface components on the substrate according to the general assembly drawing with Step 5: Test simple installation method for reliable sealing integrity and Rigorous inspections high cleanliness and tests prior to packaging and shipment

♦ Modular design - shorten design time

According to the customer's P&ID diagram, the design can be completed by installing standard substrates, valves (diaphragm valves, check valves, regulators), flowmeters, filters, pressure sensors and other components on the panel.

♦ Surface mounting - easy installation and maintenance

All components are surface mounted in accordance with SEMI standard, and installation with silver-plated screws and later maintenance can be completed with simple tools.

Miniaturization

The size is about 1/3 the traditional panel, and the corresponding flow path size is also reduced for better contamination control.

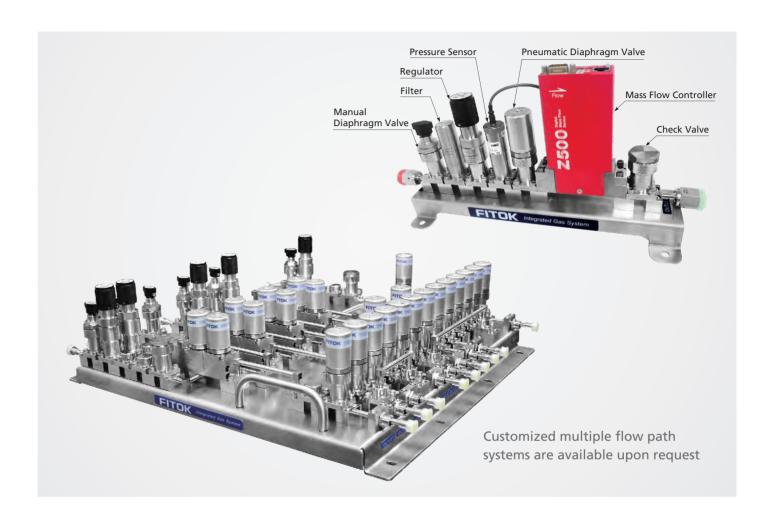
◆ SEMI standard materials, electropolishing process and orbital welding

Wetted components are made of SEMI standard materials with electropolished flow paths (Ra 5 μ in. / Ra 0.13 μ m) and orbital welded connections.

W-seal / C-seal

W-seal or C-seal between components and substrates. Metal-to-metal seal with the sealing surface isolated from components receiving external force to achieve optimal sealing effect.

FITOK can design and supply integrated gas systems according to customer P&ID diagrams, in which filters, pressure sensors and MFC can be provided by customers or purchased by FITOK under customer-provided brands.



Main Components	Features			
Diaphragm Valves	Cobalt alloy diaphragm Manual and pneumatic actuators available Body materials of 316L SS, 316L VAR and 316L VIM-VAR Wetted components electropolished to a surface finish of Ra 5 µin. (0.13 µm) max			
Check Valves	Body materials of 316L SS, 316L VAR and 316L VIM-VAR Wetted components electropolished to a surface finish of Ra 5 µin. (0.13 µm) max			
Regulators	Hastelloy poppet and diaphragm Reinforced diaphragm design improves sealing performance and service life Body materials of 316L SS, 316L VAR and 316L VIM-VAR Wetted components electropolished to a surface finish of Ra 5 µin. (0.13 µm) max			
Substrates	Non-fixed installation to ensure the sealing effect Body materials of 316L SS, 316L VAR and 316L VIM-VAR Wetted components electropolished to a surface finish of Ra 5 µin. (0.13 µm) max			
Gaskets	W-seal and C-seal optional Sealing surfaces isolated from components receiving external force Electropolished to a surface finish of Ra 5 µin. (0.13 µm) max			

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